



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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P-CHANNEL ENHANCEMENT MODE VERTICAL DMOS FET

ZVP4424A

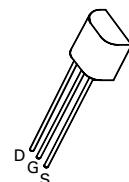
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FEATURES

- * 240 Volt V_{DS}
- * $R_{DS(on)}=9\Omega$
- * Low threshold

APPLICATIONS

- * Electronic Hook Switch



E-Line
TO92 Compatible

ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	VALUE	UNIT
Drain-Source Voltage	V_{DS}	-240	V
Continuous Drain Current at $T_{amb}=25^\circ C$	I_D	-200	mA
Pulsed Drain Current	I_{DM}	-1	A
Gate Source Voltage	V_{GS}	± 40	V
Power Dissipation at $T_{amb}=25^\circ C$	P_{tot}	750	mW
Operating and Storage Temperature Range	T_j, T_{stg}	-55 to +150	°C

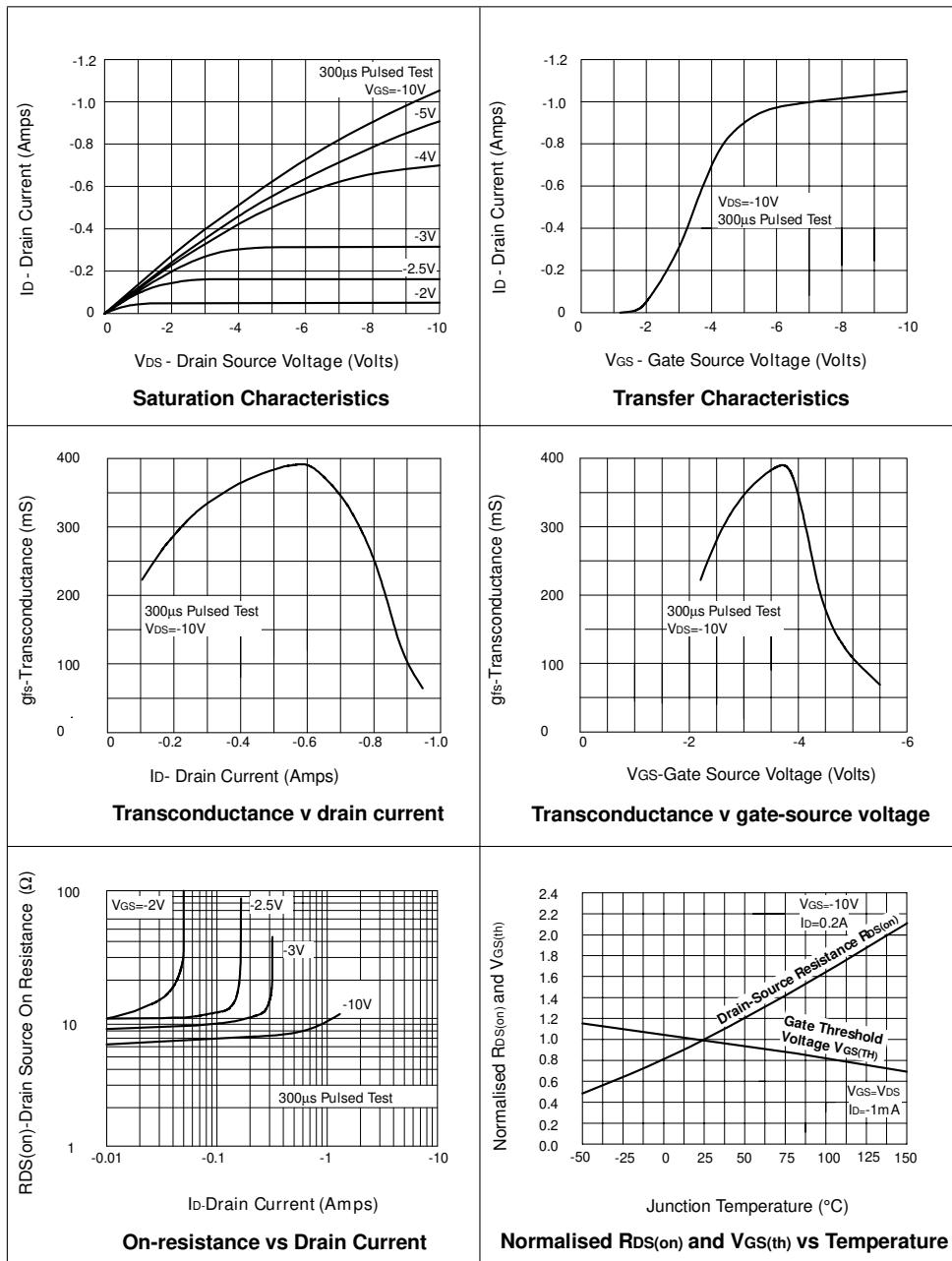
ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^\circ C$ unless otherwise stated).

PARAMETER	SYMBOL	MIN.	TYP	MAX.	UNIT	CONDITIONS.
Drain-Source Breakdown Voltage	BV_{DSS}	-240			V	$I_D=-1mA, V_{GS}=0V$
Gate-Source Threshold Voltage	$V_{GS(th)}$	-0.7	-1.4	-2.0	V	$I_D=-1mA, V_{DS}=V_{GS}$
Gate-Body Leakage	I_{GSS}			100	nA	$V_{GS}=\pm 40V, V_{DS}=0V$
Zero Gate Voltage Drain Current	I_{DSS}			-10 -100	μA μA	$V_{DS}=-240V, V_{GS}=0$ $V_{DS}=-190V, V_{GS}=0V, T=125^\circ C$
On-State Drain Current	$I_{D(on)}$	-0.75	-1.0		A	$V_{DS}=-10V, V_{GS}=-10V$
Static Drain-Source On-State Resistance	$R_{DS(on)}$		7.1 8.8	9 11	Ω Ω	$V_{GS}=-10V, I_D=200mA$ $V_{GS}=-3.5V, I_D=100mA$
Forward Transconductance (1) (2)	g_{fs}	125			mS	$V_{DS}=-10V, I_D=-0.2A$
Input Capacitance (2)	C_{iss}		100	200	pF	$V_{DS}=-25V, V_{GS}=0V, f=1MHz$
Common Source Output Capacitance (2)	C_{oss}		18	25	pF	
Reverse Transfer Capacitance (2)	C_{rss}		5	15	pF	
Turn-On Delay Time (2)(3)	$t_{d(on)}$		8	15	ns	$V_{DD}=-50V, I_D=-0.25A,$ $V_{GEN}=10V$
Rise Time (2)(3)	t_r		8	15	ns	
Turn-Off Delay Time (2)(3)	$t_{d(off)}$		26	40	ns	
Fall Time (2)(3)	t_f		20	30	ns	

(1) Measured under pulsed conditions. Width=300μs. Duty cycle ≤2% (2) Sample test.

(3) Switching times measured with 50Ω source impedance and <5ns rise time on a pulse generator

TYPICAL CHARACTERISTICS



ZVP4424A

TYPICAL CHARACTERISTICS

